L Number	Hits	Search Text	DB	Time stamp
4	8	("5437757" "5707485" "5805408" "5830808" "5920797"	USPAT	2004/06/29 11:56
6	10	"5922133" "6117349" "6200388").PN. jp-05217951-\$.did. or	USPAT;	2004/06/29 12:02
0	10	jp-03217931-\$.did. or	US-PGPUB:	2004/00/29 12.02
		jp-07310187-\$.did. or	EPO; JPO;	
1		jp-10050665-\$.did. or	DERWENT;	
İ		jp-09129612-\$.did.	IBM_TDB	•
7	60392	plasma and ring	USPAT;	2004/06/29 12:08
			US-PGPUB;	
		9	EPO; JPO; DERWENT;	
		4	IBM_TDB	
9	1195	(plasma and ring) and (conductive near5 ring)	USPAT;	2004/06/29 13:46
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM_TDB	
11	255	((plasma and ring) and (conductive near5 ring)) and (insulating	USPAT;	2004/06/29 13:02
	200	near5 ring)	US-PGPUB;	2004/00/25 10:02
		3,	EPO; JPO;	
			DERWENT;	
40	40	/#4000004# L #5004070# L #5405404# L #5550500# L #5740000# L	IBM_TDB	0004/00/00 40 45
12	10	("4282924" "5304278" "5405491" "5556500" "5740009" "5792304" "5868848" "5904778" "6096161"	USPAT	2004/06/29 12:15
		3792304 3606646 3904776 6096161 "6148765").PN.		
13	2563	118/728.ccls. or 156/345.51.ccls.	USPAT;	2004/06/29 13:03
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
14	869	(118/728.ccls. or 156/345.51.ccls.) and ring	IBM_TDB USPAT;	2004/06/20 42:02
'	003	(110/120.003. 01 100/040.01.003.) and fing	US-PGPUB;	2004/06/29 13:03
			EPO; JPO;	
		0	DERWENT;	
			IBM_TDB	
15	851	((118/728.ccls. or 156/345.51.ccls.) and ring) not (((plasma	USPAT;	2004/06/29 13:04
		and ring) and (conductive near5 ring)) and (insulating near5 ring))	US-PGPUB; EPO; JPO;	
		11119// 	DERWENT:	
			IBM TDB	
16	8	("5437757" "5707485" "5805408" "5830808" "5920797"	USPAT	2004/06/29 13:14
47	40	"5922133" "6117349" "6200388").PN.		
17	10	("5271788" "5411624" "5529657" "5556500" "5660673" "5716486" "5904799" "6074488" "6096161"	USPAT	2004/06/29 13:17
		3710466 3904799 6074468 6096161 "6117349").PN.		
18	2	6344105.URPN.	USPAT	2004/06/29 13:27
19	651	(chishio near koshimizu).in or (hiroyuki near ishihara).in. or	USPAT;	2004/06/29 13:48
		(kimihiro near higuchi).in. or (koji near maruyama).in.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
21	81	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or	IBM_TDB USPAT;	2004/06/29 13:48
		(kimihiro near higuchi).in. or (koji near maruyama).in.) and	US-PGPUB;	2004/00/25 15.40
		plasma	EPO; JPO;	
			DERWENT;	
22	650	((chichia poor koohimizu) in or (hizzunki zaaz iahikaza) in ar	IBM_TDB	0004/00/00 40 40
~~	000	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or (kimihiro near higuchi).in. or (koji near maruyama).in.) not	USPAT; US-PGPUB;	2004/06/29 13:49
		((118/728.ccls. or 156/345.51.ccls.) and ring)	EPO; JPO;	
		w and mig	DERWENT;	
		L	IBM_TDB	
20	58	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or	USPAT;	2004/06/29 13:57
		(kimihiro near higuchi).in. or (koji near maruyama).in.) and ring	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM_TDB	

-	3159	118/724,725,728.ccls. or 156/345.51,345,52,345.53.ccls.	USPAT; US-PGPUB	2002/09/22 15:55
-	625	(118/724,725,728.ccls. or 156/345.51,345,52,345.53.ccls.) and temperature same (workpiece or wafer or semiconductor or object).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:00
-	247925	118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.	USPAT; US-PGPUB	2002/09/22 15:57
-	26885	(118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.) and (control or controller or controlling).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:16
-	3717	(118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.) and ((control or	USPAT; US-PGPUB	2002/09/22 17:24
-	1636	controller or controlling) same temperature).ab,clm. ((118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object	USPAT; US-PGPUB	2002/09/22 17:00
-	119	or target)).ab,clm. (((118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object	USPAT; US-PGPUB	2002/09/22 16:08
-	1517	or target)).ab,clm.) and (ring).ab,clm. (((118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or 427/\$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) not ((((118/7\$.ccls. or 156/345.\$.ccls. or 204/\$.ccls. or 315/\$.ccls. 269/\$.ccls. or 438/\$.ccls. or	USPAT; US-PGPUB	2002/09/22 16:09
		427/\$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and (ring).ab,clm.)		
-	0	269/390.ccls.	USPAT; US-PGPUB	2002/09/22 17:00
-	23247	269/\$.ccls.	USPAT; US-PGPUB	2002/09/22 17:00
-	73	269/\$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.	USPAT; US-PGPUB	2002/09/25 13:22
-	10	269/\$.ccls. and (temperature same (ring)).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:12
_	689 229	269/\$.ccls. and (ring).ab,clm.	USPAT; US-PGPUB	2004/06/29 12:07
-	141	269/\$.ccls. and (temperature).ab,clm. (269/\$.ccls. and (temperature).ab,clm.) not ((269/\$.ccls. and	USPAT; US-PGPUB USPAT;	2002/09/22 17:13
		(ring).ab,clm.) or (269/\$.ccls. and (temperature same (ring)).ab,clm.) or (269/\$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))	US-PGPUB	2502103122 17.10
-	986	269/\$.ccls. and (control or controller or controlling).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:16
	0	((269/\$.ccls. and (temperature).ab,clm.) not ((269/\$.ccls. and (ring).ab,clm.) or (269/\$.ccls. and (temperature same (ring)).ab,clm.) or (269/\$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))) not ((269/\$.ccls. and (temperature).ab,clm.) or (269/\$.ccls. and (ring).ab,clm.) or (269/\$.ccls. and (temperature same (ring)).ab,clm.) or (269/\$.ccls. and (temperature same (wafer	USPAT; US-PGPUB	2002/09/22 17:17
-	831	or workpiece or substrate ot object or target)).ab,clm.)) (269/\$.ccls. and (control or controller or controlling).ab,clm.) not ((269/\$.ccls. and (temperature).ab,clm.) or (269/\$.ccls. and (ring).ab,clm.) or (269/\$.ccls. and (temperature same (ring)).ab,clm.) or (269/\$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))	USPAT; US-PGPUB	2002/09/22 17:18
-	43	269/\$.ccls. and ((control or controller or controlling) same temperature).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:24
-	122925	(temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.	JPO; DERWENT	2002/09/25 13:23
	- 1 1	1:50:00 DM Dogg 2		

-	6880	((temperature same (wafer or workpiece or substrate ot object	JPO;	2002/09/25 13:28
		or target)).ab,clm.) and plasma	DERWENT	
-	6625	((temperature same (wafer or workpiece or substrate ot object	JPO;	2002/09/25 13:28
		or target)).ab,clm.) and plasma.ab,clm.	DERWENT	
-	3496	(((temperature same (wafer or workpiece or substrate ot object	JPO;	2002/09/25 13:29
		or target)).ab,clm.) and plasma.ab,clm.) and gas.ab,clm.	DERWENT	
-	552	((((temperature same (wafer or workpiece or substrate of	JPO:	2002/09/25 13:29
		object or target)).ab,clm.) and plasma.ab,clm.) and	DERWENT	
		gas.ab,clm.) and (control or controller or controlling).ab,clm.		
_	1101	118/728.ccls.	USPAT:	2003/01/16 17:05
			US-PGPUB	
_	585	118/728.ccls. and ring	USPAT;	2003/01/16 17:06
		1 10/120.00ld. dild lilig	US-PGPUB	2000/01/10 17:00
_	515	(118/728.ccls. and ring) and (heat ir heating or heated or	USPAT:	2003/01/16 16:37
_	0.0	heater or heating)	US-PGPUB	2000/01/10 10:0/
	508	(118/728.ccls. and ring) and (heat or heating or heated or	USPAT;	2003/01/16 17:34
-	300	heater or heating)	US-PGPUB	2003/01/10 17.54
	2253	118/724,725.ccls.	USPAT;	2003/01/16 17:06
-	2255	110/724,723.0018.		2003/01/10 17.00
	014	440/704 705 pale, and sing	US-PGPUB	0000/04/40 47:00
-	914	118/724,725.ccls. and ring	USPAT;	2003/01/16 17:33
		(#5.427757# #5707.405# #5005.400# #5020000# #5020707#	US-PGPUB	0000/04/40 47 00
-	8	("5437757" "5707485" "5805408" "5830808" "5920797"	USPAT	2003/01/16 17:08
	2004	"5922133" "6117349" "6200388").PN.	LICDAT	0000/04/40 47.00
-	3284	156/345.\$.ccls.	USPAT;	2003/01/16 17:33
		450,045 0 4 4 4	US-PGPUB	
-	1424	156/345.\$.ccls. and ring	USPAT;	2003/01/16 17:34
			US-PGPUB	
-	949	1 (USPAT;	2003/01/16 17:36
		heater or heating)	US-PGPUB	
-	731	((156/345.\$.ccls. and ring) and (heat or heating or heated or	USPAT;	2003/01/16 18:02
		heater or heating)) not (((118/728.ccls. and ring) and (heat or	US-PGPUB	
		heating or heated or heater or heating)) or (118/724,725.ccls.		
		and ring))		
-	143806	plasma	JPO;	2003/01/16 18:02
			DERWENT	
-	5328	plasma and ring	JPO;	2003/01/16 18:35
			DERWENT	
-	785	(plasma and ring) and (heat or heating or heater or heated)	JPO:	2003/01/16 18:04
			DERWENT	
_	102	plasma and (focus adj ring)	JPO;	2003/01/16 18:35
		, , , , , , , , , , , , , , , , , , ,	DERWENT	
_	95	(plasma and (focus adj ring)) not ((plasma and ring) and (heat	JPO;	2003/01/16 18:35
		or heating or heater or heated))	DERWENT	
	10.	i an area and a company of the meaning of the meani		